



PRODUCT DATA SHEET



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Datasheet



Resources

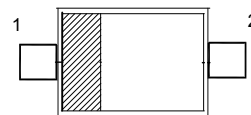


Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.

Features

- Low forward voltage
- Low reverse capacitance



SOD-123


Absolute Maximum Ratings (T_a = 25 °C)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	SD101AW SD101BW SD101CW	60 50 40	V
Reverse Voltage	SD101AW SD101BW SD101CW	60 50 40	V
Forward Continuous Current	I _{FM}	15	mA
Power Dissipation	P _d	400	mW
Non-Repetitive Peak Forward Surge Current	at t = 1 s at t = 10 μs	50 2	mA A
Operating and Storage Temperature Range	T _j , T _{stg}	- 65 to + 125	°C

Characteristics at T_a = 25 °C

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I _R = 10 μA	SD101AW SD101BW SD101CW	60 50 40	- - -	V
Forward Voltage at I _F = 1 mA	SD101AW SD101BW SD101CW	- - -	0.41 0.4 0.39	V
at I _F = 15 mA	SD101AW SD101BW SD101CW	- - -	1 0.95 0.9	V
Reverse Current at V _R = 50 V at V _R = 40 V at V _R = 30 V	SD101AW SD101BW SD101CW	- - -	200 200 200	nA
Total Capacitance at V _R = 0 V, f = 1 MHz	SD101AW SD101BW SD101CW	- - -	2 2.1 2.2	pF
Reverse Recovery Time at I _F = I _R = 5 mA, I _{rr} = 0.1X I _R , R _L = 100 Ω	t _{rr}	-	1	ns

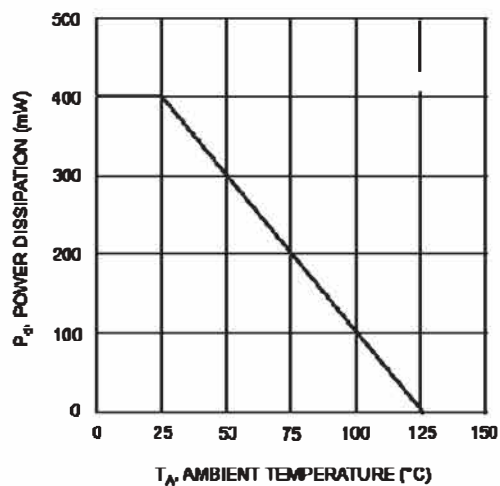


Fig. 1 Power Derating Curve

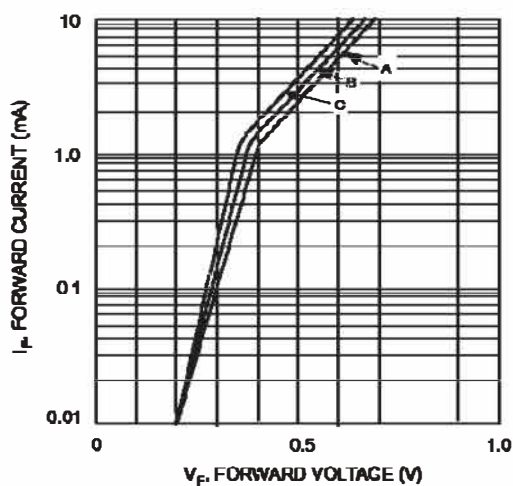


Fig. 2 Typical Forward Characteristic

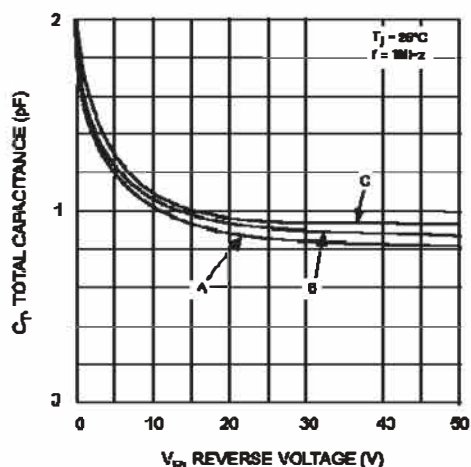


Fig. 3 Typical Total Capacitance vs Reverse Voltage

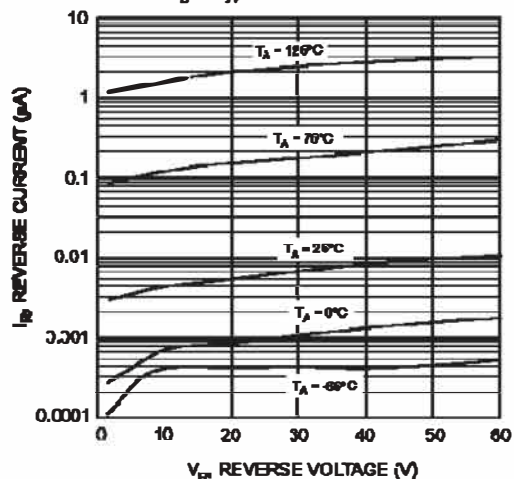
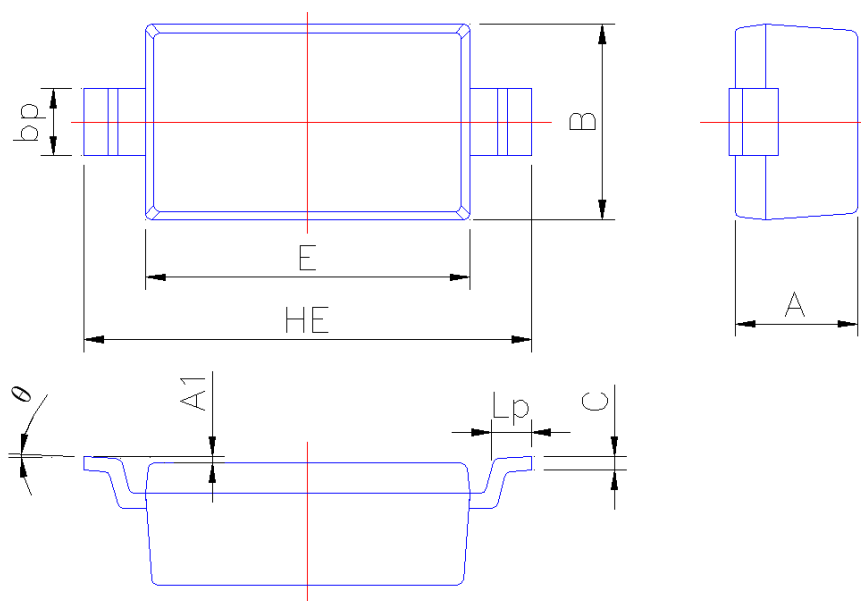


Fig. 4 Typical Reverse Characteristics

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123



Symbol	Dimension in Millimeters	
	Min	Max
A	0.95	1.15
A1	0.01	0.100
B	1.55	1.65
bp	0.50	0.70
C	0.09	0.150
E	2.60	2.70
HE	3.45	3.85
Lp	0.20	0.45
θ	0°	5°

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